

ABSTRACT OF THE DISCLOSURE

Disclosed is a system including a circuit board and several pluggable modules
5 coupled to the circuit board. The several pluggable modules are insertable through side-
by-side slots in an enclosure in which the circuit board resides. A first pluggable module
is coupled to the circuit board via a first connector, while a second pluggable module is
coupled to the circuit board via a second connector such that the second pluggable
module is laterally offset from the first pluggable module. The first and second
10 connectors are right angle connectors, and the second right angle connector is inverted
relative to the first right angle connector. The first and second pluggable modules are I/O
modules for transporting high speed differential signals, and wherein the first pluggable
module includes several XFP connectors, and wherein the second pluggable module
includes several SFP connectors. The second pluggable module includes several SFP
15 connectors arranged on both sides of the pluggable module.